# MI1210K600R-10

# UNCONTROLLED DOCUMENT

Rated

Current

1500 mA

## PHYSICAL DIMENSIONS:

MPEDANCE

A 3.20 [.126] ± 0.20 [.008]

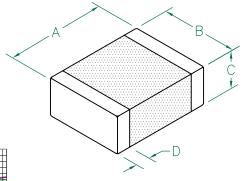
B 2.50 [.098] ± 0.20 [.008]

C 1.40 [.055] + 0.20 [.008]

D 0.46 [.018] ± 0.20 [.008]

Z vs FREQUENCY IMPEDANCE UNDER DC BIAS

FREQUENCY (MHz)





	•		•	
NOTES:	UNLES:	S OTHERW	ISF SF	PECIFIED

60

45

75

**ELECTRICAL CHARACTERISTICS:** 

DCR

 $(\Omega)$ 

0.035

Z @ 100MHz

 $(\Omega)$ 

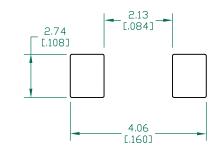
Nominal

Minimum Maximum

- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 3000 PCS/REEL. EMBOSSED PLASTIC TAPE.
- 2. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 3. TERMINATION FINISH IS 100% TIN.
- 4. OPERATING TEMP. RANGE: -40°C~+125°C. (INCLUDING SELF-HEATING)

#### LAND PATTERNS FOR REFLOW SOLDERING

### RECOMMENDED SOLDERING CONDITIONS



REFLOW SOLDERING

255
PRE-HEATING
SOLDERING
255 ± 5°C

[491]

230
[446]

180
[356]

130
[266]

WHITE

65 SECONDS Min 90–120 SECONDS

(For wave soldering, add 0.762 (0.030) to this dimension)

	120 -	Z	, R,	AND	X v	s. Ff	REQUE	NCY	 
(	100 -								
IMPEDANCE $(\Omega)$	80 - 60 -						z		
IMPEDA	40 -						XL		
	20 -								
			10		UEN	CY (	100 (MHz)		1000

AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 3124



	DIMENSIONS ARE IN mm [INCHE	This print is the property of Laird							
				Tech, and is loaned in confidence subject to return upon request and with the understanding that no			_	<b>=</b>	<b>.</b>
							7	ir(	
				copies shall be made without the written consent of Laird Tech.	_	u		<b>Y</b>	
D	ADD OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13		rights to design or invention are reserved.					
С	UPDATE COMPANY LOGO	08/26/08	JRK	PROJECT/PART NUMBER:	RE	٧	PART TY	PE:	DRAWN BY:
В	ADD ROHS SYMBOL; UPDATE TAPE NOTE	08/31/07	JRK	MI1210K600R-10		D	CO-	FIRE	JRK
	UPDATE COMPANY LOGO		_	F'''''' ∩4 /13 /∩4 I	SCALE:	N.	TS	SHEET:	
Α	ORIGINAL DRAFT	04/13/04	JRK		TOOL 6			_	
REV	DESCRIPTION	DATE	INT		,		-	2	of 2